

Pulse-output Interface Embedded 3D Pedometer Module STP100M

---Applicable for Non Wrist Pedometer Products (like pedometer in pocket, on belt or shoes)

I. Description

STP100M is a 3D pedometer functional chipset which include a G-sensor and MCU. It has adopted the pulse-type interface, with the 3D MEMS sensor (G sensor) and high precision of 3D pedometer algorithm, it can give a precisely pedometer in any direction. This module has the characteristics of small size, low power and etc. The simple digital interface ensures it can be easily embedded in various kinds of pedometer functional system.

★Note: The algorithm of our pedometer is adjustable according to customer's requirement.

We can provide the pedometer for shoes, table class pedometer and bracelet pedometer wearing on wrist, pedometer wearing on waist and pedometer putting inside the pocket.Pls indicate clearly whe n purchasing.

II. Features:

- High precision 3D pedometer algorithm
- Ultra-small size

- Low sleep current
- Pulse output interface

III. Application

- 3D pedometer
- MP3 pedometer
- Outdoor handheld

- Healthcare products
- Pedometer shoes

IV. Performance parametric

Parametric	condition	performance			Linit
		MIN	TYP	MAX	Unit
Working voltage		2.3	3	3.6	V
Working current	@3V		<25		uA



Sleep current			<4		⊌ uA
Pedometer resolution			1		Step
Pedometer error	Uniform working		±3%		Step
Working temperature		-10		50	${\mathbb C}$
Storage temperature		-10		50	$^{\circ}$

V. Working mode

1) Normal work mode

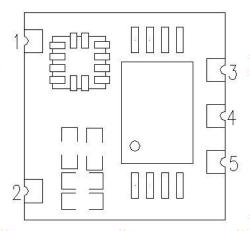
The chipset goes into normal working mode when step motion is detected.

The Step-out pin is in low level usually, it will output one high pulse with one step motion, and the high level of the pulse is around 50ms.

2) Sleep mode

If the module doesn't automatically come to sleep status within 20 seconds, the G sensor doesn't work, the entire pedometer chipset in low power consumption mode, then the current is less than 4uA!

3) Pin Definition:

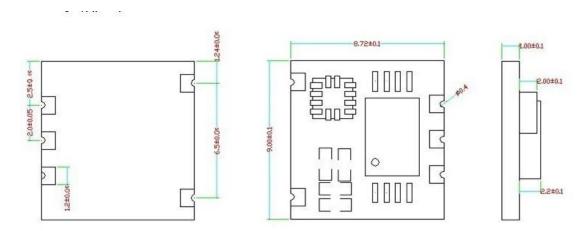


Pin NO.	Pin name	Description
1	GND	Connect ground
2	GND	Connect ground
3	VCC	Connect positive power (2.3-3.6V)
4	GND	Connect ground



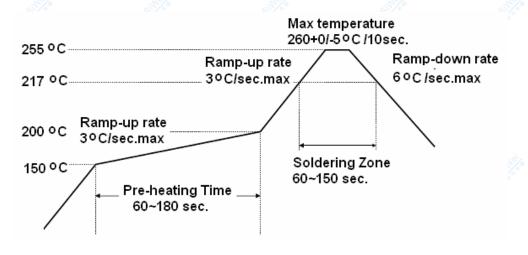
	13.7.1	13.4.3	18.4.1	19.7.1	18.7.7	
5	STEP	Pulse-output pin				

VI. Dimension:



VII. Soldering condition

1) Soldering temperature curve



- 2) Don't reflow more than twice
- 3) Don't press the chip when during the soldering
- 4) Don't bent circuit board after the soldering.

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